

## PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Ramakrishna C. Dhanekula</td><td>12/03/2008</td></tr><tr><td>Kenny C. Gross</td><td>11/28/2008</td></tr></tbody></table>	Name	Execution Date	Ramakrishna C. Dhanekula	12/03/2008	Kenny C. Gross	11/28/2008	
Name	Execution Date						
Ramakrishna C. Dhanekula	12/03/2008						
Kenny C. Gross	11/28/2008						
RECEIVING PARTY DATA							
Name:	SUN MICROSYSTEMS, INC.						
Street Address:	4150 Network Circle						
City:	Santa Clara						
State/Country:	CALIFORNIA						
Postal Code:	95054						
PROPERTY NUMBERS Total: 1							
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12331173</td></tr></tbody></table>	Property Type	Number	Application Number:	12331173			
Property Type	Number						
Application Number:	12331173						
CORRESPONDENCE DATA							
Fax Number:	(530)759-1665						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
Phone:	530-759-1663						
Email:	edward@parklegal.com						
Correspondent Name:	Edward J. Grundler						
Address Line 1:	Park, Vaughan & Fleming, LLP						
Address Line 2:	2820 Fifth Street						
Address Line 4:	Davis, CALIFORNIA 95618						
ATTORNEY DOCKET NUMBER:	SUN08-0620						
NAME OF SUBMITTER:	Edward J. Grundler, Reg. No. 47,615						
Total Attachments: 2 source=SUN08-0620_Assignment#page1.tif source=SUN08-0620_Assignment#page2.tif							

OP \$40.00 12331173

PATENT

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REEL: 022199 FRAME: 0350

## CORPORATE ASSIGNMENT

WHEREAS, the undersigned,

Ramakrishna C. Dhanekula  
Kenny C. Gross

7665 Palmilla Drive #5121, San Diego, CA 92122  
10228 Jeraback Drive, San Diego, CA 92131

hereinafter termed "Inventor(s)", have invented certain new and useful improvements in

*GENERATING EXTENDED DATA FROM A PATTERN-RECOGNITION MODEL FOR A COMPUTER SYSTEM*

and have executed a declaration or oath for an application for a United States patent disclosing and identifying the invention:

\_\_\_ On the \_\_\_ day of \_\_\_\_\_, 20\_\_\_;

Or

X Said application having Application Number 12/331,173 and filed on 09 December 2008; and

WHEREAS, SUN MICROSYSTEMS, INC. a corporation of the State of Delaware, having a place of business at 4150 Network Circle, Santa Clara, CA 95054, (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventor(s) (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor(s) to have been received in full from said Assignee:

1. Said Inventor(s) do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventor(s) hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings,

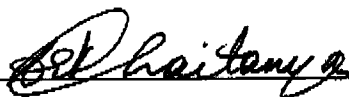
Attorney Docket No. SUN08-0620

infringement actions and court actions; provided, however, that the expense incurred by said Inventor(s) in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor(s), their respective heirs, legal representatives and assigns.

4. Said Inventor(s) hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor(s) have executed and delivered this instrument to said Assignee as of the dates written below.



Ramakrishna C. Dhanekula

Date

12/03/2008



Kenny C. Gross

Date

11.28.08

Date

Date

Date